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27th IEEE International System-on-Chip Conference

\$0CC 2014

Sept. 3-5, 2014, Las Vegas, Nevada, USA

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Call For Papers





The IEEE SoC Conference (SOCC) is a premier forum for sharing advances in SoC technologies and applications in the areas of digital systems, circuit architectures, computing platforms, design methods, automations, test, and emerging technologies. SOCC2014 offers a three-day technical program including keynote and plenary speeches, oral and poster presentations, hot-topic panel sessions and tutorials, and exhibitions. This year the SOCC introduces a "Design Track" to encourage engineers to present their work and share their knowledge and experience on issues and practical solutions in the development of SoC designs. SOCC2014 also provides a high quality social events program, including a Las Vegas show, conference banquet, and a tour of the cavernous powerhouse of Hoover Dam hydro-electric plant. *Contact us: info@ieee-socc.org*.

Submission of Papers and Workshop/Tutorial/Special Session Proposals

Online paper submissions are in *pdf* format, limited to **six** double-column IEEE format pages. Paper submissions will go through a double-blind peer review process. The SOCC proceedings will be submitted to IEEE *Xplore*. Workshop/tutorial proposals with title, a one-page summary, and speaker's short bio are submitted to the Tutorial Chair. *Special session* proposals may include title, topic rationale, organizer's short bio, and a list of contributed papers, which are submitted to the TPC Chairs. "*Design Track*" submissions require a two-page extended abstract which will be published on the SOCC website and in the program. For detailed formatting instructions and submission guidelines, please refer to www.ieee-socc.org.

SOCC Areas of Interest

Papers are invited which address new and previously unpublished results in the areas:

- ◆Analog and Mixed-Signal Circuits and Systems
- **→**Biomedical Circuits and Systems
- +Wireline and Wireless Communication Circuits and Systems
- *Digital Signal Processing (DSP) Circuits and Systems
- *Low-Power, "Green" Circuits, Systems, and Design Methodologies
- ◆Embedded Systems, Multi/Many Core Systems & Embedded Memory Technologies
- ◆Network on Chip (NoC), Interconnects, and 3D-IC
- *Reconfigurable and Programmable Circuits and Systems
- +System Level Design Methodology and Tools
- ◆Design for Testability and Manufacturability
- →Design Verification
- +Computing Platform Architectures

Key Dates

Special session proposal submission deadline:

Regular paper submission deadline:

Workshop/tutorial proposal submission deadline:

Design Track extended abstract due:

Notification of acceptance:

Final camera-ready paper due:

March 10th, 2014

April 31st, 2014

April 8th, 2014

April 14th, 2014

June 10th, 2014

June 30th, 2014

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